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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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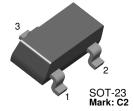




BCW30

PNP General Purpose Amplifier

- This device is designed for general purpose medium power amplifiers and switches requiring collector currents to 300mA.
- Sourced from process 68.



1. Base 2. Emitter 3. Collector

Absolute Maximum Ratings * $T_C=25$ °C unless otherwise noted

Symbol	Parameter		Value	Units
V_{CEO}	Collector-Emitter Voltage		-32	V
V _{CES}	Collector-Emitter Voltage		-32	V
V _{EBO}	Emitter-Base Voltage		-5.0	V
I _C	Collector current - Contin	uous	-500	mA
T _J , T _{stq}	Junction and Storage Temperature		-55 ~ +150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- NOTES:

 1) These ratings are based on a maximum junction temperature of 150 degrees C.

 2) These are state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Electrical Characteristics $T_C=25^{\circ}C$ unless otherwise noted

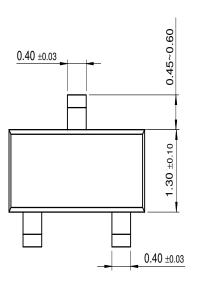
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
Off Charact	teristics					
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = -10\mu A, I_E = 0$	-32			V
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	$I_C = -2.0 \text{mA}, I_B = 0$	-32			V
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	$I_C = -10\mu A, I_E = 0$	-32			V
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_C = -10\mu A, I_C = 0$	-5.0			V
I _{CBO}	Collector Cutoff Current	$V_{CB} = -32V, I_{E} = 0$			-100	nA
		$V_{CB} = -32V, I_{E} = 0, T_{A} = +100^{\circ}C$			-10	μΑ
On Charact	On Characteristics					
h _{FE}	DC Current Gain	$V_{CE} = -5.0V, I_{C} = -2.0mA$	215		500	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = -10 \text{mA}, I_B = -0.5 \text{mA}$			-0.3	V
V _{BE(on)}	Base-Emitter On Voltage	$V_{CE} = -5.0V, I_{C} = -2.0mA$	-0.6		-0.7	V
Small Signal Characteristics						
NF	Noise Figure	$V_{CE} = -5.0V, I_{C} = -200\mu A$			10	dB
		$R_S = 2.0k\Omega$, $f = 1.0kHz$				
		B _W = 200Hz				

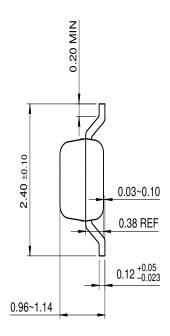
Thermal Characteristics $T_A=25$ °C unless otherwise noted

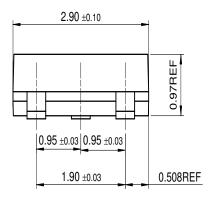
Symbol	Parameter	Max.	Units
P _D	Total Device Dissipation	350	mW
	Derate above 25°C	2.8	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

Package Dimensions

SOT-23







Dimensions in Millimeters

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Rev. I1

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition		
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.		
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